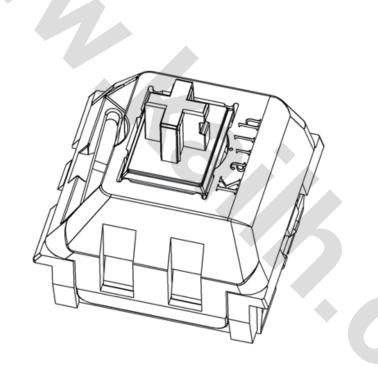




Document Number:

KH-PS1705-22

# **Product Specification**



P/N:

CPG151101D212

Title:

PG1511 Keyboard Switch



# **Product Specification**

P/N: DOC. No.:

KH-PS1705-22

Rev.:

Page: 2/11

### Content

CPG151101D212

1.	Scope
2.	Product Application
	Technology Parameters
	Ratings
5.	Profile Dimensions
6.	Electrical Performance
7.	Mechanical Performance
8.	Environmental Performance
9.	Recommended PCB Layout
10.	Loading Parameter Specification
	Precaution



#### **KAIHUA ELECTRONICS**

### **Product Specification**

P/N: DOC. No.: Rev.: Page:

CPG151101D212 KH-PS1705-22

v.: Page: 3/11

#### 1. Scope:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

#### 2. Product Application:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

#### 3. Technology Parameters:

Ambient Humidity: 45 ~ 85% RH

Operating Temperature Range: -10°C ~ +70°C Storage Temperature Range: -20°C ~ +70°C Suggested storage period: about 6 months

Require the tin part on the switch terminals should keep good after storage guarantee date

#### Normal Condition:

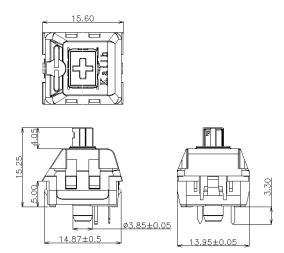
Ambient temperature: 20±2°C Relative humidity: 65%±5%RH Air pressure: 86~101KPa

#### 4. Ratings

Rating: 12V AC/DC max. 2V DC min

10mA AC/DC max. 10μA DC min Insulation Resistance: ≥100MΩ/DC 500V Withstand Voltage: 100 AC 1 Minute Mechanical Life: 70,000,000 Cycles

#### 5. Profile Dimensions





Product	<b>Specification</b>

P/N: DOC. No.:

CPG151101D212

KH-PS1705-22

Rev.:

Page: 4/11

#### 6. Electrical Performance

Item	Description	Test Condition	Requirement
6.1	Contact Resistance	Static load: (Operation force)x2, which is applied on the center of Switch stem.  Measurement tool: Contact resistance Meter. (1KHz,20mV,5~50mA)  Measured at low current (100mA or less).	100mΩ Max
6.2	Insulation Resistance	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	100mΩ Min
Dielectric withstanding voltage  Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method.  (1) Between terminals.  (2) Between terminal and Body.		No evidence of breakdown	
6.4	Bouncing	Operation speed: 3~4 times/s Oscillo scope Switch Bouncing Test Circuit  D. C. 10V 10mA 10KΩ 0scillo Scope Switch Bouncing Test Circuit "ON" "OFF"	Before Life cycle: On: 5ms MAX Off: 5ms MAX After Life cycle: On: 10ms MAX Off: 10ms MAX



Product	<b>Specification</b>
	Opodilioation

P/N: DOC. No.:

CPG151101D212

KH-PS1705-22

Rev.:

**Page:** 5/11

#### 7. Mechanical Performance

Item	Description	Test Condition	Requirement
7.1	Load Curve	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.  Force-Travel-diagram  120 100 80 60 12 33.5 (mm)	See page 11
7.2	Loading parameter	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.  Mounting Surface	See page 11

# Kailh KAIHUA ELECTRONICS

# **Product Specification**

P/N: DOC. No.: Rev.: Page: C 6/11

7.3	Static Strength	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds.  No (El And m			)
7.4	Stem Pull Strength	Measured by according to the below condition:  (1) Acceleration: 80g  (2) Cycles of test: 3 cycles each in 6			
7.5	Shock				
7.6 Life Test  2) Operation speed: 5-6 times / s  3) Push force: 150gf  4) Push travel: 3 5mm  1000n  Bound Opera		1000m0 Bouncir Operation	t resistance Ω Max ng: 10ms M on force: V hin ±30%	lax	



<b>Product Specification</b>
------------------------------

P/N: DOC. No.: CPG151101D212

KH-PS1705-22

Rev.: С

Page: 7/11

#### **Environmental Performance**

Item	Description	Test Condition	Requirement
8.1	Cold test	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2	
8.2	Heat test	<ul> <li>(1) Temperature: 70±2°C</li> <li>(2) Duration of test: 48h</li> <li>(3) Take off a drop water</li> <li>(4) Standard conditions after test: 1h</li> </ul>	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2
8.3	Temperature cycle	(1) Test cycles: 5 cycles (2) Standard condition after test: 1h  Temperature Duration of test 20±5°C 1h -20±2°C 1h 20±5°C 1h 70±5°C 1h	Contact resistance: 200mΩ Max Shall meet: No. 6.2 to 6.4 No. 7.1 to 7.2

### **Product Specification** Kailh P/N: DOC. No.: Rev.: Page: **KAIHUA ELECTRONICS** С 8/11 CPG151101D212 KH-PS1705-22 Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) Soldering Appearance: 8.4 Soldering temperature: 260±5°C No abnormality. heat test Soldering time: 5±0.5s 1. Hand soldering: Please practice according to below condition: (1) Soldering Temperature: 350±5°C (2) Continual soldering time: 3±0.5s (3) Capacity of soldering iron: ≤20w 2. Automatic PIP soldering: At least 95% of surface area For the product of T/H according to below of immersed portion shall be condition: 8.5 Solder ability covered by solder. Wave Soldering Temperature Curve (Single Wave Peak) 200



# **Product Specification**

 P/N:
 DOC. No.:
 Rev.:
 Page:

 CPG151101D212
 KH-PS1705-22
 C
 9/11

╙							
	8.6	Humidity test	(2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water		200mΩ N Shall me No. 6.2 to	Contact resistance: 200mΩ Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2	
	8.7	Salt Spray	Apply the following environment to test (1) Temperature: 35±5°C (2) Salt water density: 5±1% (3) Duration: 12hours (4) After test, the salt deposit shall be removed by running water.		no base	sion spot, plate nake Resistanc	
	8.8	Withstand K <sub>2</sub> S	Apply the following environment to test: (1) Temperature: 35±5°C (2) K2S Density: 2% (3) Duration: 2 minute.		crack, no	sion spot, base pla Resistanc	te naked.



#### **KAIHUA ELECTRONICS**

## **Product Specification**

P/N: DOC. No.:

CPG151101D212

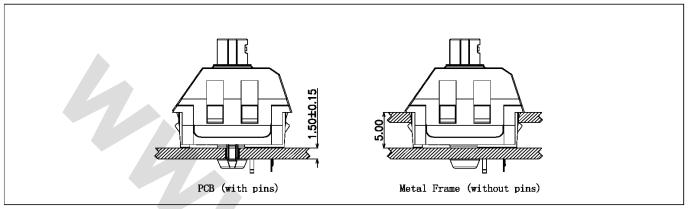
KH-PS1705-22

Rev.:

Page: 10/11

#### 9. Recommended PCB Layout

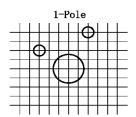
#### Mounting Options

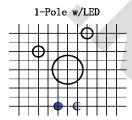


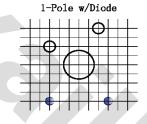
#### Circuit Board Layouts

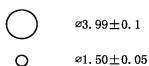
Grid line spacing = 1.27mm

Keyswitch without fixation pins



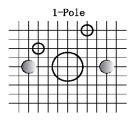


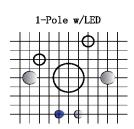


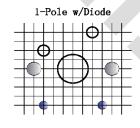


● Ø1.0±0.1

Keyswitch with fixation pins





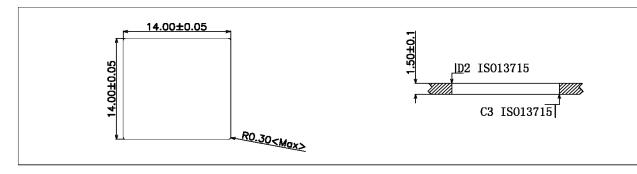




 $\emptyset 3.99 \pm 0.1$   $\emptyset 1.70 \pm 0.05$ 

Ø1.50±0.05 Ø1.0±0.1

#### Metal Frame Cutout Dimensions





P/N: DOC. No.: Rev.: Page: C 11/11

#### 10. Loading Parameter (FP/OP/PT/ OF /OT) Specification

Parameter	Unit	Specification	Remark
FP mm		15.25 ± 0.2	
OP	mm	14.15 ± 0.6	
PT	mm	1.1 <sup>+0.4</sup> <sub>-0.2</sub>	
OF	gf	40 ± 10	
ОТ	mm	2.0	Min
TT	mm	3.5 ± 0.4	

#### 11.Precaution

#### 11.1 Immersion Soldering condition

ITEM	CONDITION
Preheat temperature	110°C Max (Ambient temperature of soldering surface of P.W.B)
Preheat time	60s, Max
Area of flux	1/2 Max of PWB Thickness
Temperature of solder	260±5°C
Time of immersion	Within 5s
Number of soldering	2time Max (But should down heat of the first soldering)
Printed wiring board	Single side copper-clad laminates

- (1) After switches were soldered, please be careful not to clean switches with solvent
- (2) Under the condition of using soldering iron, soldering temperature shall be 350°C max within 3 sec.

#### **11.2 Notes**

- (1) Please be cautious not to give excessive static load or shock to switches.
- (2) Please be careful not to stack up P. W. B. after switches were soldered.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton.
- (4) Products meet the ROHS & REACH environmental management substances control standards.